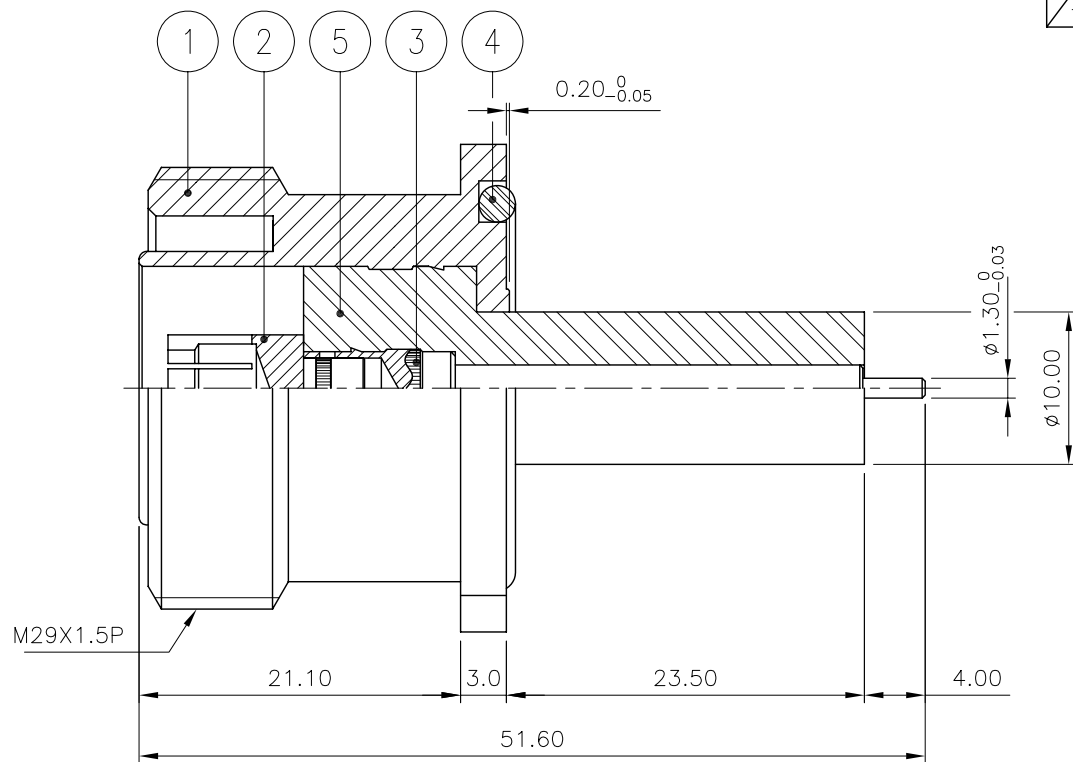
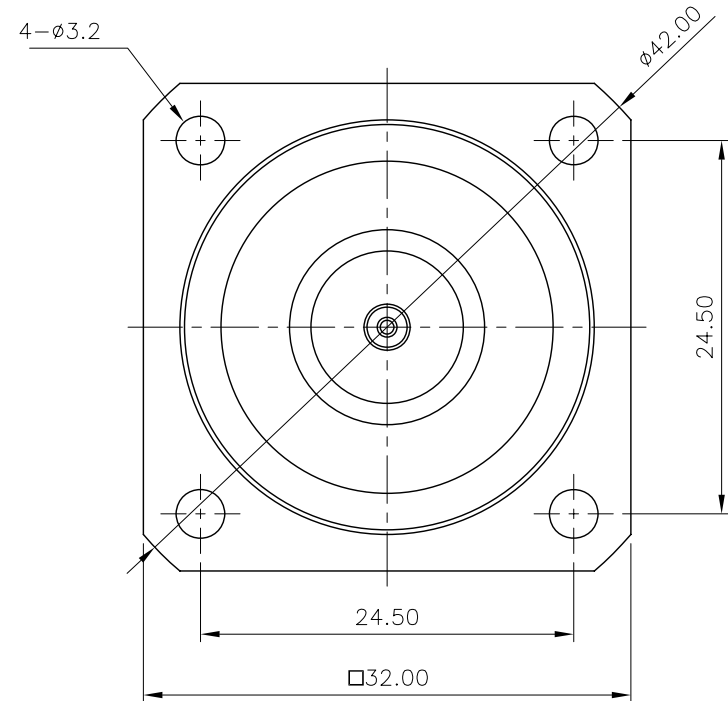




REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	M.H.SONG	I.C.KIM	2014.03.20.
1	[설번No.201405-0006]전기적 특성개선(CONTACT,INSULATOR 구조 변경)	M.H.SONG	I.C.KIM	2014.05.23.



6	BOLT	1	SUS	Passivate	DBT00102-N/1
5	INSULATOR	1	TEFLON		DIN02366-N/1
4	GASKET	1	SILICONE Rub		DGK00199-N/1
3	CONTACT	1	MBsBD	Silver 3.0 μ m min.	DCT03137-5/1 DCT03079-5/1
2	CONTACT	1	BeCu	Silver 3.0 μ m min.	DCT02074-5/1 DCT01858-5/1
1	BODY	1	MBsBD	SUCO 3.0 μ m min.	DBD03598-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2014. 05. 23.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY	E.H.KIM	KJ COMTECH CO.,LTD. TITLE 7/16 DIN50 SOLDER END JS-4H
		DRAWN BY	M.H.SONG	
FINISH		SCALE	UNIT	A4 DWG NO. CN03195-7/1 REVISION 1 SHEET 1 of 1
		2/1	mm	